

### 12500 TI Boulevard, MS 8640, Dallas, Texas 75243

# PCN#20200527000.1 Add Cu as Alternative Wire Base Metal for Selected Device(s) Change Notification / Sample Request

**Date:** May 28, 2020 **To:** Flextronics PCN

### Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

We request you acknowledge receipt of this notification within **30** days of the date of this notice. Lack of acknowledgement of this notice within 30 days constitutes acceptance of the change. If you require samples or additional data to support your evaluation, please request within 30 days.

The proposed first ship date is indicated on page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Team (<u>PCN\_ww\_admin\_team@list.ti.com</u>). For sample requests or sample related questions, contact your field sales representative.

Sincerely,

PCN Team SC Business Services

### 20200527000 Attachment: 1

### **Products Affected:**

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

**DEVICE** LM45BIM3/NOPB **CUSTOMER PART NUMBER** 

PBE-453561386151

Technical details of this Product Change follow on the next page(s).

<b>PCN Number:</b> 20200527000.1		7000.1	1			PCN Date: May 28		3, 2020			
Title:	Add Cu as Alternative Wire Base Metal for Selected Device(s)										
Custome	Customer Contact: PCN Manager Dept: Quality Services										
Proposed 1 <sup>st</sup> Ship Date: Aug 28		8 2	020	Estimate							
•		<b>P</b> 2466.	/ lag _			Av	aila	ability: sample request		est	
Change					Danima			1 \\\-6-	. D	- C:t-	
	mbly Site			붜	Design	Data Sheet		Wafer Bump Site			
	mbly Pro mbly Mat			붜		mber change	⊬	Wafer Bump Material Wafer Bump Process			
		ecification		퓜	Test Si		╁		r Fab S		5
		oing/Labeli		퓜	Test Pr		╁┾	-		Materials	
	9/ 0	Jiiig, Labeli	9	<u> </u>			╁┾			rocess	
					PCN	Details		- 1			
Descript	ion of C	hange:									
for select	Texas Instruments is pleased to announce the qualification of Cu as an additional bond wire option for selected devices listed in "Product affected" section below. Devices will remain in current assembly facilities and there will be no other piece part changes:										
		Pkg Fam	ily		С	urrent Wire	Additional Wire				
	SOT-23	3, SOT-SC	70, VSS	OP	A	u, 0.9/1.0mil	Cu, 0.96 mil				
Reason f	Reason for Change:										
1) To aliq electri 2) Maxim	Continuity of supply.  1) To align with world technology trends and use wiring with enhanced mechanical and electrical properties  2) Maximize flexibility within our Assembly/Test production sites.  3) Cu is easier to obtain and stock										
Anticipat	Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):										
None											
	Anticipated impact on Material Declaration										
No Impact to the Material Declaration  Material Declaration  Material Declaration  Material Declaration or Product Content reports are driven from production data and will be available following the production release. Upon production release the revised reports can be obtained at the site link below <a href="http://www.ti.com/quality/docs/materialcontentsearch.tsp">http://www.ti.com/quality/docs/materialcontentsearch.tsp</a>						on e					
Changes	Changes to product identification resulting from this PCN:										
None											

<b>Product Affected:</b>	Product Affected:						
LM26CIM5-BPB/NOPB	LM26CIM5X-ZHA/NOPB	LM71CIMF/NOPB	LM95235DIMM/NOPB				
LM26CIM5-DPB/NOPB	LM27CIM5-1HJ/NOPB	LM71CIMFX/NOPB	LM95235DIMMX/NOPB				
LM26CIM5-HHD/NOPB	LM27CIM5-2HJ/NOPB	LM86CIMM/NOPB	LM95235EIMM/NOPB				
LM26CIM5-NPA/NOPB	LM27CIM5-ZHJ/NOPB	LM86CIMMX/NOPB	LM95241CIMM-1/NOPB				
LM26CIM5-PHA/NOPB	LM27CIM5X-1HJ/NOPB	LM89-1CIMM/NOPB	LM95241CIMM-2/NOPB				
LM26CIM5-RPA/NOPB	LM27CIM5X-2HJ/NOPB	LM89-1CIMMX/NOPB	LM95241CIMM/NOPB				
LM26CIM5-SHA/NOPB	LM45BIM3	LM89-1DIMM/NOPB	LM95241CIMMX/NOPB				
LM26CIM5-SPA/NOPB	LM45BIM3/NOPB	LM89-1DIMMX/NOPB	LM95245CIMM				
LM26CIM5-TPA/NOPB	LM45BIM3X/NOPB	LM89CIMM/NOPB	LM95245CIMM-1/NOPB				
LM26CIM5-VHA/NOPB	LM45CIM3/NOPB	LM89CIMMX/NOPB	LM95245CIMM/NOPB				
LM26CIM5-VPA/NOPB	LM45CIM3X	LM90CIMM/NOPB	LM95245CIMMX-1/NOPB				
LM26CIM5-XHA/NOPB	LM45CIM3X/NOPB	LM90CIMMX/NOPB	LM95245CIMMX/NOPB				
LM26CIM5-XPA/NOPB	LM60BIM3	LM94021BIMG/NOPB	LM99-1CIMM/NOPB				
LM26CIM5-YHA/NOPB	LM60BIM3/NOPB	LM94021BIMGX/NOPB	LM99CIMM/J7002180				
LM26CIM5-YPA/NOPB	LM60BIM3X	LM94022BIMG	LM99CIMM/NOPB				
LM26CIM5-YPE/NOPB	LM60BIM3X/NOPB	LM94022BIMG/NOPB	LM99CIMMX/NOPB				
LM26CIM5-ZHA	LM60CIM3	LM94022BIMGX/NOPB	LMT84DCKR				
LM26CIM5-ZHA/NOPB	LM60CIM3/NOPB	LM95010CIMM/NOPB	LMT84DCKT				
LM26CIM5X-DPB/NOPB	LM60CIM3X	LM95071CIMF	LMT85DCKR				
LM26CIM5X-HHD/NOPB	LM60CIM3X/NOPB	LM95071CIMF/NOPB	LMT85DCKT				
LM26CIM5X-NPA/NOPB	LM61BIM3	LM95071CIMFX	LMT86DCKR				
LM26CIM5X-PHA/NOPB	LM61BIM3/NOPB	LM95071CIMFX/NOPB	LMT86DCKT				
LM26CIM5X-SPA/NOPB	LM61BIM3X/NOPB	LM95221CIMM/NOPB	LMT87DCKR				
LM26CIM5X-TPA/NOPB	LM61CIM3	LM95221CIMMX/NOPB	LMT87DCKT				
LM26CIM5X-VHA/NOPB	LM61CIM3/NOPB	LM95231BIMM-1/NOPB	LMT88DCKR				
LM26CIM5X-VPA/NOPB	LM61CIM3X/NOPB	LM95231CIMM-1/NOPB	LMT88DCKT				
LM26CIM5X-XHA/NOPB	LM62BIM3/NOPB	LM95231CIMM-2/NOPB	LMT89DCKR				
LM26CIM5X-XPA/NOPB	LM62BIM3X/NOPB	LM95231CIMM/NOPB	LMT89DCKT				
LM26CIM5X-YHA/NOPB	LM62CIM3/NOPB	LM95231CIMMX/NOPB	LMT90DBZR				
LM26CIM5X-YPA/NOPB	LM62CIM3X/NOPB	LM95235CIMM/NOPB	LMT90DBZT				
LM26CIM5X-YPE/NOPB	LM71CIMF	LM95235CIMMX/NOPB					

### **Qualification Data**

Approved on 08/17/2015

Qualification of 0.96 mils Cu wires on SOT-SC70 Package

# Qualification Results Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: LMV7275MG/NOPB	Supporting QBS: LM4041AIM3-1.2 (TL)	Supporting QBS: LM4041AIM3-1.2 (TL)
HAST	Biased HAST, 130C/85%RH	96 Hours	-	3/231/0	3/231/0
AC	Autoclave 121C	96 Hours	-	3/231/0	-
TC	Temperature Cycle, - 65/150C	500 Cycles	1/77/0	-	-
тс	Temperature Cycle, - 65/150C	1000 Cycles	-	3/231/0	-
HTSL	High Temp Storage Bake 150C	500 Hours	1/77/0	2/154/0	1/77/0
HTSL	High Temp Storage Bake 150C	1000 Hours	1/77/0	2/154/0	1/79/0
MQ	Manufacturability (Assembly)		1/pass	1/pass	1/pass

- QBS: Qual By Similarity
- Qual Device LMV7275MG/NOPB is qualified at LEVEL1-260C
- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
- The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
- The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours
- The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

Green/Pb-free Status: Qualified Pb-Free(SMT) and Green

# **Qualification Data**

Qualification of 0.96 mils Cu wires on SOT23 Packages

### **Qualification Results**

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: LM4041AIM3-1.2	Qual Device: LP3985IM5X-5.0	Qual Device: LMC7101AIM5NOPB	Qual Device: LM431CCM3NOPB
PC	PreCon Level 1	Level 1- 260C	3/693/0	3/462/0	3/693/0	3/462/0
HAST	Biased HAST, 130C/85%RH	96/hrs. @130C	3/231/0	-	3/231/0	-
AC	Autoclave 121C	96HRS	3/231/0	3/231/0	3/231/0	3/231/0
TC	Temperature Cycle, -65/150C	TMCL500X	3/231/0	3/231/0	3/231/0	3/231/0
HTSL	High Temp Storage Bake 150C	1000 hrs. @150C	1/77/0	-	1/77/0	1/77/0

MQ	Manufacturability (Assembly)	(per mfg. Site specification)	Pass	Pass	Pass	Pass
DPA	Destructive Physical Analysis Post 500 Temp Cycle	x-section and de process to examine assembly robustness, Check for stich bond and bond pad integrity	3/15/0	3/15/0	3/15/0	3/15/0
YLD	FTY and Bin Summary	Compare against baseline	Pass	Pass	Pass	Pass

- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
- The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
- The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours
- The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles Quality and Environmental data is available at Tl's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

## **Qualification Data**

Qualification of 0.96 mils Cu wires VSSOP Packages

#### **Qualification Results**

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: LMV852MMX	Qual Device: LMC6482IMM		
PC	PreCon Level 1	Level 1-260C	3/462/0	3/462/0		
HAST	Biased HAST, 130C/85%RH	96/hrs. @130C	-	-		
AC	Autoclave 121C	96HRS	3/231/0	3/231/0		
TC	Temperature Cycle, -65/150C	TMCL500X	3/231/0	3/231/0		
HTSL	High Temp Storage Bake 150C	1000 hrs. @150C	-	-		
MQ	Manufacturability (Assembly)	(per mfg. Site specification)	Pass	Pass		
DPA	Destructive Physical Analysis Post 500 Temp Cycle	x-section and de process to examine assembly robustness, Check for stich bond and bond pad integrity	3/15/0	3/15/0		
YLD	FTY and Bin Summary	Compare against baseline	Pass	Pass		

- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
- The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
- The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours
- The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles Quality and Environmental data is available at Tl's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com

### IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale (<a href="www.ti.com/legal/termsofsale.html">www.ti.com/legal/termsofsale.html</a>) or other applicable terms available either on <a href="ti.com">ti.com</a> or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.